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SHEET 1 OF 23

Form PTO 1449 (Modified)

U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE

T NO. 248402US99DK ATTY DOCKET NO.

APPLICANT

SERIAL NO.

10/767,994

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	AF	4,523,211	06/11/85	Morimoto et al.			
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SHEET 2 OF 23 Form PTO 1449 U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE ATTY DOCKET NO. SERIAL NO. (Modified) 248402US99DIV 10/767,994 **APPLICANT** LIST OF REFERENCES CITED BY APPLICANT Jamal RAMDANI, et al. FILING DATE GROUP February 2, 2004 2815 **U.S. PATENT DOCUMENTS EXAMINER** DOCUMENT DATE NAME CLASS SUB FILING DATE ΛΙΣΙΤΙΑΙ NUMBER IF APPROPRIATE **CLASS** 3,766,370 10/16/73 Walther CB 4,006,989 02/08/77 Andringa CC 4,284,329 08/18/81 Smith et al. CD 4,777,613 10/11/98 Shahan et al. CE 4,802,182 01/31/89 Thornton et al. CF 4,882,300 11/21/89 noue et al. CG 4,896,194 01/23/90 Suzuki CH 4.999.842 03/12/91 Huang et al. 5,081,062 01/14/92 Vasudev et al. 5,155,658 CJ 10/13/92 nam et al. ĊК 5,248,564 09/28/93 Ramesh CL 5,260,394 11/09/93 Tazaki et al. СМ 5,270,298 12/14/93 Ramesh CN 5,286,985 02/15/94 Taddiken $\overline{\mathsf{co}}$ 5,310,707 05/10/94 Oishi et al. $\overline{\cap}$ 5,326,721 07/05/94 Summerfelt ca 5,404,581 04/04/95 Honjo CR 5,418,389 05/23/95 Watanabe cs 5,436,759 07/25/95 Dijali et al. 5,576,879 11/19/96 Nashimoto CU 5,606,184 02/25/97 Abrokwah, et al. ĈΫ 5.640.267 06/17/97 May et al. 5,674,366 10/07/97 Hayashi et al. ĈX 5,729,641 03/17/98 Chandonnet et al. CY 5,790,583 08/04/98 CZ 5,825,799 10/20/98 Ho et al. DA 5,857,049 01/05/99 Beranek et al. DB 5,874,860 02/23/99 Brunel et al. DC 5,926,496 07/20/99 Ho et al. ממ 5,937,285 08/10/99 Abrokwah, et al. DE 5,981,400 11/09/99 lDF 5,990,495 11/23/99 Ohba DG 6,002,375 12/14/99 Corman et al. H 6,008,762 12/28/99 Nghiem וח 6,055,179 04/25/00 Koganei et al. D 6,107,653 08/22/00 Fitzgerald DK 6,113,690 09/05/00 Yu et al. DL 6,114,996 09/05/00 Nghiem DM 6,121,642 09/19/00 Newns

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SHEET 4 OF 23

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	GC	4,888,202	12/89	Murakami et al.		†	
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	GE	5,051,790	09/24/91	Hammer			
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	GK	5,194,397	03/16/93	Cook et al.			
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JF 5,966,323 10/99 Chen et al. JG 5,987,011 11/16/99 Toh JH 6,022,140 02/08/00 Fraden et al. JI 6,022,410 02/08/00 Yu et al. JJ 6,023,082 02/08/00 McKee et al. JK 6,028,853 02/22/00 Haartsen JL 6,049,702 04/11/00 Tham et al. JM 6,078,717 06/20/00 Nashimoto et al JN 5,088,216 07/00 Laibowitz et al. JO 6,090,659 07/00 Laibowitz et al. JP 6,107,721 08/22/00 Lakin JQ 6,153,010 11/28/00 Ayoku et al		JD	5,948,161	09/07/99	Kizuki			
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JI 6,022,410 02/08/00 Yu et al. JJ 6,023,082 02/08/00 McKee et al. JK 6,028,853 02/22/00 Haartsen JL 6,049,702 04/11/00 Tham et al. JM 6,078,717 06/20/00 Nashimoto et al JN 6,088,216 07/00 Laibowitz et al. JO 6,090,659 07/00 Laibowitz et al. JP 6,107,721 08/22/00 Lakin JQ 6,153,010 11/28/00 Ayoku et al			1					
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SHEET 6 OF 23

Form PTO 1449 (Modified)		U.S. DEPARTMENT OF COM PATENT AND TRADEMARK OFF		ATTY DOCKET NO. 248402US99DIV		SERIAL	NO. 10/767,994
				APPLICANT		<u> </u>	10/10/,994
LIST OF	REFE	ERENCES CITED BY AP	PLICANT		RAMDANI,	et al.	
				FILING DATE		GROUP	0045
		···	•	February 2, 2004		<u> </u>	2815
				U.S. PATENT DOCUMENTS			-
EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB	FILING DATE IF APPROPRIATE
16/MI-	KA	6,153,454	11/28/00	Krivokapic		05,00	1 73 1 10 1 13 14
	кв	6,191,011	02/01	Gilboa et al		·	
+	кс	6,204,737	03/20/01	Ella	 		
	KD	6,224,669	05/01/01	Yi et al.	1		
	KE	6,225,051	05/01/01	Sugiyama et al.			
	KF	6,241,821	06/05/01	Yu et al.	-	·	. /
	KG	6,265,749	07/24/01	Gardner et al.			
	кн	6,313,486	11/01	Kencke et al.		-	. /
	KI	6,316,832	11/13/01	Tsuzuki et al.	1.		/
	KJ	2002/0008234	01/02	Emrick .	+		/
	KK	3,670,213	06/13/72	Nakawaga et al.	+		
-	KL	4,756,007	07/05/88	Qureshi et al.			
	KM	4,773,063	09/20/88	Hunsperger et al.		-	/
	KN	5,394,489	02/28/95	Koch	<u> </u>		· / · · · · ·
	ко	5,406,202	04/11/95	Mehrgardt et al.	 		
	KP	5,528,067	06/18/96	Farb et al.	-		
	ΚQ	5,572,052	11/05/96	Kashihara et al.	+ .		 - - - - - -
	KR	5,767,543	06/16/98	Ooms et al.	 		1
-	KS	6,175,497	01/16/01	Tseng et al.	+		1
	KT	6,197,503	03/06/01	Vo-Dinh et al.	- 		/
	KU	6,248,459	06/19/01	Wang et al.	+		
	ΚV	6,252,261	06/26/01	Usui et al.	-	<u> </u>	
	кw	6,255,198	07/03/01	Linthicum et al.	+	/	
	кx	6,268,269	07/31/01	Lee et al.		 	
	KY	6,291,319	09/18/01	Yu et al.		 	
	KZ	6,316,785	11/13/01	Nunoue et al.		 	
	LA	6,343,171	01/29/02	Yoshimura et al.		 	
	LB	4,965,649	10/23/90	Zanio et al.	†	/	_
	LC	6,253,649	05/01	Kawahara et al.	1	 	
	LD	6,211,096	04/01	Allman et al.	+	/ 	
	LE	6,239,449	05/29/01	Fafard et al.	 	 /	
	LF	2001/0013313	08/16/01	Droopad et al.		/	·
	LG	6,184,044	02/06/01	Sone et al.	1		***
	LH	6,011,646	01/04/00	Mirkarimi et al.	 		
	LI	5,227,196	07/13/93	itoh	 . 		
	LJ	6,150,239	11/21/00	Goesele et al.	 		
	rk.	5,441,577	08/15/95	Sasaki et al.	+-+		
	LL	4,459,325	07/10/84	Nozawa et al.	+ /		
	LM	4,392,297	07/12/83	Little	 		
	LN	4,289,920	09/15/81	Hovel	+-/-		
	LO	5,281,834	01/25/94	Cambou et al.	+/-		
	LP	4,901,133	02/7/3/90	Curran et al.	+/		
	La	5,514,904	05/07/96	Onga et al.	1/	 	
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SHEET 7 OF 23

Form PTO 1449 (Modified)	P	U.S. DEPARTMENT OF COMMI		ATTY DOCKET NO.	· · · · · · · · · · · · · · · · · · ·	SERIAL	
(i-comes)	• •			248402US99DIV		L	10/767,994
LIST OF	REFE	RENCES CITED BY APP	LICANT	APPLICANT Jamal R	AMDANI,	et al.	
				FILING DATE .		GROUP	
_			•	February 2, 2004		L	2815
#X4141XED		DOCUMENT	Γ	U.S. PATENT DOCUMENTS		CLID	FILING DATE
EXAMINER		DOCUMENT NUMBER	DATE	NAME .	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE
N/VVI5	MA	5,553,089	09/03/96	Seki et al.			
	МВ	5,528,057	06/18/96	Yanagase et al.			
	МС	6,229,159	05/08/01	Suzuki			
	MD	4,748,485	05/31/88	Vasudev			
	ME	4,984,043	01/08/91	Vinal			
	MF	5,754,319	05/19/98	Van De Voorde et al.			
	MG	6,108,125	08/22/00	Yano			
	МН	5,073,981	12/17/91	Giles et al.			
	MI	5,140,651	08/18/92	Soref et al.			
,	MJ	5,610,744	03/11/97	Ho et al.			
	MK	6,362,017	03/26/02	Manabe et al.			
	ML	6,242,686	06/05/01	Kishimoto et al.			
	ММ	5,689,123	11/18/97	Major et al.			7
	MN	5,670,800	09/23/97	Nakao et al.			
	МО	5,067,809	11/26/91	Tsubota			/
	MP	5,596,205	01/21/97	Reedy et al.			1
	MQ	6,175,555	01/16/01	Hoole			
	MR	5 ,357,122	10/18/94	Okubora et al.			1
	MS	4,084,130	04/11/78	Holton ·			1
	мт	6,093,302	07/25/00	Montgomery		4	/
	MU	6,372,813	04/16/02	Johnson et al.			
	ΜV	5,608,046	03/04/97	Cook et al.		/	
	MW	5,955,591	09/21/99	Imbach et al.		1	
	MX	6,022,963	02/08/00	McGall et al.		7	
	MY	6,083,697	07/04/00	Beecher et al.		7	
	MZ	5,063,081	11/05/91	Cozzette et al.			
	NA	5,479,317	12/26/95	Ramesh			
	NB	5,306,649	04/26/94	Hebert		7	
	NC	5,962,069	10/05/99	Schindler et al.		7	
	ND	5,541,422	07/30/96	Wolf et al.			
	NE	5,873,977	02/23/99	Desu et al.			
	NF	5,538,941	07/23/96	Findikoglu et al.			
	NG	6,046,464	04/04/00	Schetzina			
	NH	6,235,145	05/22/01	Li et al.			
	NI	5,610,744	03/11/97	Ho et al.			
	NJ	5,280,013	01/18/94	Newman et al.			
	NK	6,348,373 B1	02/19/02	Ma et al.			
11	NL	6,339,664 B1	01/15/02	Farjady et al.			
	NM	4,439,014	03/27/84	Stacy et al.	7		
	NN	4,889,402	12/26/89	Reinhart			
	NO	5,963,291	10/05/99	Wu et al.	/		
	NP	6,011,641	01/04/09	Shin et al.			
	NQ	6,340,788 B1	01/22/02	Kingg et al.			
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Sheets 8 OF 23

Form PTO 1449 (Modified)	P	U.S. DEPARTMENT OF COMM ATENT AND TRADEMARK OFFI	ERCE CE	ATTY DOCKET NO. 248402US99DIV		SERIAL	NO. 10/767,994	
				APPLICANT				
LIST OF	REFE	RENCES CITED BY APP	PLICANT		AMDANI			
				FILING DATE		GROUP		
				February 2, 2004			2815	
CVALUED		DOCUMENT		U.S. PATENT DOCUMENTS		T 2002	· !	
NITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB	FILING DATE IF APPROPRIATE	
KANIZ	OA	5,807,440	09/15/98	Kubota et al.	 	 	/	
	ОВ	4,681,982	07/21/87	Yoshida	 	 	/	
	ос	4,629,821	12/16/86	Bronstein-Bonte et al.	 -		/	
	OD	4,452,720	06/05/84	Harada et al.		 	/	
	OE	3,935,031	01/27/76	Adler	 		 	
1	OF	5,760,426	06/02/98	Marx et al.		 		
	OG	5,053,835	10/01/91	Horikawa et al.		-	 	
_	ОН	6,326,645 B1	12/04/01	Kadota			 /	
	OI	5,770,887	06/23/98	Tadatomo et al.			 	
_	Ol	6,372,356 B1	04/16/02	Thomton et al.		 	 /	
1	ОК	4,774,205	09/27/88	Choi et al.	 	 	 	
	OL OL	6,359,330 B1	03/19/02	Goudard	 	 	 /	
	OM	5,312,765	05/17/94	Kanber		 	 	
-	ON	5,734,672	03/11/94	McMinn et al.		<u> </u>	 	
-	00	6,367,699 B2	04/09/02	Ackley	ļ	 	 	
			06/25/96	Stefik et al.	 		<i> </i>	
	OP	5,530,235					 -/	
	00	5,623,552	04/22/97	Lane	ļ		 	
 	OR	5,481,102	01/02/96	Hazelrigg, Jr.			/	
	os	6,134,114	10/17/00	Ungermann et al.	ļ		<i>/</i>	
	ОТ	5,984,190	11/16/99	Nevin				
	ΟU	5,789,733	08/04/98	Jachimowicz et al.		/		
	ΟV	5,753,300	05/19/98	Wessels et al.	<u> </u>			
	ow	6,208,453	03/27/01	Wessels et al.				
	ОХ	5,886,867	03/23/99	Chivukula et al.				
	OY	5,028,976	07/02/91	Ozaki et al.				
	OZ	5,869,845	02/09/99	Vander Wagt et al.				
	PA	5,596,214	01/21/97	Endo			-	
	РВ	6,391,674 B2	05/21/02	Ziegler		\mathcal{I}		
	PC	6,275,122 B1	08/14/01	Speidell et al.				
	PD	6,238,946 B1	05/29/01	Ziegler		1		
	PE	6,210,988 B1	04/03/01	Howe et al.				
	PF	6,392,257	05/21/02	Ramdani et al.				
	PG	4,442,590	04/17/84	Stockton et al.	1		-	
	PH	5,603,764	02/18/97	Matsuda et al.	/			
	PI	6,087,681	06/11/00	Shakuda	1			
	PJ	5,132,648	07/21/92	Trinh et al.	/			
	PK	6,427,066	07/30/02	Grube				
1 -1	PL	2002/0072245	06/13/02	Ooms et al.	-/-		<u> </u>	
1	РМ	6,278,138 B1	08/21/01	Suzuki	/			
	PN	5,888,296	03/30/99	Ooms et al.	/			
7	PO	5,198,269	03/3093	Swartz et al.	/			
\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	PP	2002/0030246	03/14/02	Eisenbeiser et al.	/			
	PQ	2002/00/7143	04/25/02	Ramdani et al.	/			
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SHEET-9 OF 23

Form PTO 1449 (Modified)		U.S. DEPARTMENT OF COMME		ATTY DOCKET NO.		SERIAL	11	
(11.00.11.00)	•		•	248402US99DIV APPLICANT		10/767,994		
LIST OF REFERENCES CITED BY APPLICANT				Jamai RAMDANI, et al.				
				FILING DATE .		GROUP		
				February 2, 2004			2815	
	•			U.S. PATENT DOCUMENTS	· · · · · · · · · · · · · · · · · · ·			
EXAMINER		DOCUMENT	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE	
INITIAL		NUMBER	07/07/00	Oshuth at at		CLASS	IF AFFRORNATE /	
\$hB	QA	5,776,359	07/07/98	Schultz et al.	ļ ———		/- -{	
	QB	5,569,953	10/29/96	Kikkawa et al.	 		/- -	
	QC	5,834,362	11/10/98	Miyagaki et al.			/	
	QD	6,248,621 B1	06/19/01	Wilk et al.	 			
	QE	5,266,355	11/30/93	Wemberg et al.			/_	
	QF	6,277,436 B1	08/21/01	Stauf et al.	ļ			
	QG	6,039,803	03/21/00	Fitzgerald et al.				
	QH	5,619,051	04/08/97	Endo				
	QI	5,420,102	05/30/95	Harshavardhan et al.				
	QJ	5,210,763	05/11/93	Lewis et al.				
	QΚ	5,103,494	04/07/92	Mozer	ļ			
	QL	4,594,000	06/10/86	Falk et al.				
	QM	4,297,656	10/27/81	Pan				
	QN	5,244,818	09/14/93	Jokers et al.	<u> </u>			
	QO	6,048,751	04/11/00	D'Asaro et al.				
	QP	5,484,664	01/16/96	Kitahara et al.				
	QQ	5,780,311	07/14/98	Beasom et al.				
	QR	6,438,281 B1	08/20/02	Tsukamoto et al.				
	QS	5,399,898	03/21/95	Rostoker				
	QT	6,271,619	08/07/01	Yamada et al.				
	Qυ	5,334,556	08/02/94	Guldi				
	Q٧	4,910,164	03/20/90	Shichijo				
	QW	4,952,420	08/28/90	Walters				
	QX	6,121,647	09/19/00	Yano et al.				
	QY	6,306,668 B1	10/23/01	McKee et al.		1		
	QZ	6,143,366	11/07/00	Lu				
 	RA	6,410,941	06/25/02	Taylor et al.				
	RB	5,397,428	03/14/95	Stoner et al.		7 .		
 	RC	6,432,546 B1	08/13/02	Ramesh et al.		/		
	RD	6,345,424	02/12/02	Hasegawa et al.		/		
	RE	6,338,756 B2	01/15/02	Dietze		1		
-	RF	5,516,725	05/14/96	Chang et al.	1			
	RG	4,667,212	05/19/87	Nakamura	1			
	RH	5,629,534	05/13/97	Inuzuka et al.	1 1			
 	RI	3,914,137	10/21/75	Huffman et al.	1-1-			
 	RJ	5,753,928	05/19/98	Krause	 	1		
 	RK	5,977,567	11/02/99	Verdiell	 	 		
 	RL	5,130,762	07/14/92	Kulick	11	1		
	RM	5,621,227	04/15/97	Joshi	† <i>†</i>	 		
 	RN	6,389,209 B1	05/14/02	Suhir	+/			
 	RO	5,163,118	11/10/92	Lorenzo et al.	 /	1		
	RP	5,926,493	07/20/99	O'Brien et al.	/			
			96/2 194		1	 		
	RQ	5,323,023	y0/21/94	Fork /	1	<u> </u>	<u> </u>	

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SHEET 10 OF 23

Form PTO 1449 (Modified)	PA	U.S. DEPARTMENT OF COMME		ATTY DOCKET NO.		SERIAL	
(• • •			248402US99DIV APPLICANT			10/767,994
LIST OF REFERENCES CITED BY APPLICANT					AMDANI,	et al.	
				FILING DATE GROUP			
				February 2, 2004			2815
				J.S. PATENT DOCUMENTS	·		
EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE
BING	SA	6,156,581	12/05/00	Vaudo et al.	<u> </u>		
To 1	SB	5,395,663	03/07/95	Tabata et al.			/·/·
	sc	4,146,297	03/27/79	Alfemess et al.			
	SD	5,452,118	09/19/95	Maruska			
	SE	5,889,296	03/30/99	Imamura et al.			
	SF	6,300,615 B1	10/09/01	Shinohara et al.	•	•	
	SG	6,232,910 B1	05/15/01	Bell et al.			
	SH	5,686,741	11/11/97	Ohori et al.			
	SI	4,959,702	09/25/90	Moyer et al			
	SJ	6,100,578	08/08/00	Suzuki	1		
	SK	6,410,947 B1	06/25/02	Wada			
	SL	6,417,059 B2	07/09/02	Huang	<u> </u>		
	SM	6,461,927 B1	10/08/02	Mochizuki et al.			
	SN	6,462,360 B1	10/08/02	Higgins, Jr. et al.	<u> </u>	·	
	so	5,981,976	11/09/99	Murasato			
	SP	5.981,980	11/09/99	Miyajima et al.			
	SQ	2002/0006245 A1	01/17/02	Kubota et al.			1
	SR	2002/0000243 A1	09/19/02	Litvin			1
			07/03/01	Duchet			
	SS	6,256,426 B1	08/21/01	Gorecki	 		
	ST	6,278,523 B1	11/20/01	Ramdani et al.	 	 	
	SU	6,319,730 B1	06/11/02		 	/	
	sv	6,404,027	11/06/01	Hong et al. Jia et al.		 	
	sw	6,312,819 B1		Schaefer et al.	 	 	,
	SX	5,119,448	06/02/92		 	 / -	
	SY	4,120,588	10/17/78	Chaum	 	 	
	SZ	5,194,917	03/16/93	Regener	 	 	
	TA	5,018,816	05/28/91	Murray et al.	 	 	
	ТВ	5,953,468	09/14/99	Finnila et al.	 	 	•
	TC	5,561,305	10/01/96	Smith	 	 	
	TD	5,896,476	04/20/99	Wisseman et al.	 	 	
	TE	4,934,777	06/19/90	Jou et al.		 	<u> </u>
	TF	6,320,238 B1	11/20/01	Kizilyalli et al.	 	 	
	TG .	6,393,167 B1	05/21/02	Davis et al.		 	
	TH	5,760,427	06/02/98	Onda	 	4	
	TI	6,411,756 B2	06/25/02	Sadot et al.	 		
	TJ	5,668,048	09/16/97	Kondo et al.	↓ · <i> </i> -	ļ	
	TK	5,852,687	12/22/98	Wickham	 		
	TL	5,122,852	06/16/92	Chan et al.	 		
	TM	5,173,835	12/22/92	Cornett et al.	 -	<u> </u>	
	TN	5,055,835	10/08/91	Sutton	1 /		ļ
	то	6,139,483	. 10/31/00	Seabaugh et al.	1/_	<u> </u>	·
	ΤP	5,283,462	0/2/01/94	Stengel	1/	L	
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	WL	4,177,094	12/04/79	Kroon			
	WM	5,216,359	06/01/93	Makki et al.		7	
	WN	6,307,996 B1	10/23/01	Nashimoto et al.		7	
	wo	5,371,621	12/06/94	Stevens		7	
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	wa	3,617,951	11/02/71	Anderson			
	WR	5,838,053	11/17/98	Bevan et al.		7	
	ws	5,684,302	11/04/97	Wersing et al.		7	
	WT	5,959,308	09/28/99	Shichijo et al.			
	.wu	5,362,972	11/08/94	Yazawa et al.	1 7		
4	w	5,864,171	01/26/99	Yamamoto et al.	1		
17/	ww	5,028,563	07/02/91	Feit et al.			
17	wx	5,937,1,95	08/10/99	-Pomash	7		
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	WZ	4,801,184	01/31/89	Revelli			
	XA	5,140,387	08/18/92	Okazaki et al.			
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	хс	6,064,783	05/16/00	Congdon et al.			
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	XP	6,181,920 B1	01/30/01	DENT ET AL	<u> </u>		
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	XR	5,760,740	06/02/98	BLODGETT	<u> </u>		
	xs	5,238,877	08/24/93	RUSSELL			
	хт	4,876,218	10/24/89	PESSA ET AL			
	XU	6,232,242 B1	05/15/01	HATA ET AL			
	χv	4,378,259	03/29/83	HASEGAWA ET AL			
	xw	6,278,541 B1	08/21/01	BAKER			
	XY	4,298,247	11/03/81	MICHELET ET AL			
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	YA	3,758,199	09/11/73	THAXTER			
	YB	6,362,558 B1	03/26/02	FUKUI			
	YC	6,140,746	10/31/00	MIYASHITA ET AL	1		
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	YL	6,498,358 B1	12/24/02	LACH ET AL	17		
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	\coprod	YR	5,919,515	07/06/99	YANO ET AL	Τ			
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		YT	5,540,785	07/30/96	DENNARD ET AL				
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